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NO. 039 P. 1

AMENDMENT UNDER 37 C.F.R. 1.116  
REQUEST FOR EXPEDITED PROCEDURE  
EXAMINING GROUP 2814

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Hua Ji  
Assignee: Mosel Vitelic, Inc.  
Title: HDP CVD Process For Void-Free Gap Fill Of A High Aspect Ratio Trench  
Serial No.: 10/080,468 Filing Date: February 22, 2002  
Examiner: Anh D. Mai Group Art Unit: 2814  
Docket No.: M-12589 US Confirmation No.: 8384

Irvine, California  
May 12, 2004

Via Facsimile to (703) 872-9306

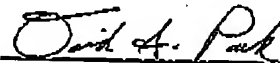
Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**CERTIFICATION OF FACSIMILE TRANSMISSION**

I hereby certify that the following documents are being facsimile transmitted to the  
U.S. Patent and Trademark Office on the date shown below:

- (1) Transmittal Letter (1 pg.); (2) Petition for Extension of Time (1 pg.); and  
(3) Response to Final Office Action w/Attachment A - Declaration of Larry Chen (17 pgs.).

Dated: May 12, 2004



David S. Park  
Registration No. 52,094

Number of pages (including this sheet): 20

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Fax to USPTO

Serial N. 10/080,468

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May 12, 2004

**AMENDMENT UNDER 37 C.F.R. 1.116  
REQUEST FOR EXPEDITED PROCEDURE  
EXAMINING GROUP 2814**Via Facsimile to (703) 872-9306Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Re: Applicant: Hua Ji  
 Assignee: Mosel Vitelic, Inc.  
 Title: HDP CVD Process For Void-Free Gap Fill Of A High Aspect Ratio Trench  
 Serial No.: 10/080,468  
 Examiner: Anh D. Mai  
 Docket No.: M-12589 US

Filed: February 22, 2002  
Group Art Unit: 2814

Dear Sir:

Transmitted herewith are the following documents in the above-identified application:

- (1) Certificate of Facsimile Transmission (1 page);
- (2) This Transmittal Letter (1 page);
- (3) Petition for Extension of Time (1 page);
- (4) Response to Final Office Action (12 pages); and
- (5) Attachment 1: Declaration of Larry Chen Under Rule 1.132 (5 pages).

- ☐ No additional fee is required.  
☒ The fee has been calculated as shown below:

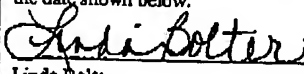
**CLAIMS AS AMENDED**

	Claims Remaining <u>After Amendment</u>		Highest No. Previously Paid For		Present Extra	Rate	Additional Fee
Total Claims	27	Minus	30	=	0	x \$18.00	\$ 0
Independent Claims	3	Minus	3	=	0	x \$84.00	\$ 0
							\$

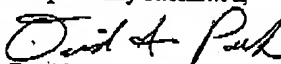
**Total additional fee for this Amendment:**

- ☒ Conditional Petition for Extension of Time: If an extension of time is required for timely filing of the enclosed document(s) after all papers filed with this transmittal have been considered, an extension of time is hereby requested. \$ 110.00
- ☒ Please charge our Deposit Account No. 50-2257 in the amount of \$ 110.00
- ☒ Also, charge any additional fees required and credit any overpayment to our Deposit Account No. 50-2257

Total: \$ \$110.00

Certificate of Facsimile Transmission	
I hereby certify that this correspondence is being facsimile transmitted to the United States Patent and Trademark Office on the date shown below.	
	May 12, 2004
Linda Bolter	Date of Signature

Respectfully submitted,

  
 David S. Park  
 Attorney for Applicants  
 Reg. No. 52,094

MAY. 12. 2004 4:09PM

MAY 12 2004  
MACPHERSON KWOK CHEN

NO. 039 P. 3

**OFFICIAL**AMENDMENT UNDER 37 C.F.R. 1.116  
REQUEST FOR EXPEDITED PROCEDURE  
EXAMINING GROUP 2814IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Hua Ji  
Assignee: Mosel Vitelic, Inc.  
Title: HDP CVD Process For Void-Free Gap Fill Of A High Aspect  
Ratio Trench  
Serial No.: 10/080,468 Filing Date: February 22, 2002  
Examiner: Anh D. Mai Group Art Unit: 2814  
Docket No.: M-12589 US

Irvine, California  
May 12, 2004Via Facsimile to (703) 872-9306Mail Stop AF  
COMMISSIONER FOR PATENTS  
P.O. Box 1450  
Alexandria, VA 22313-1450**PETITION FOR EXTENSION OF TIME**

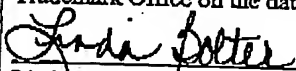
Dear Sir:

Applicant respectfully petitions for a one (1)-month extension of time within which to respond to the Final Office Action mailed by the U.S. Patent and Trademark Office on January 12, 2004, such extension allowing the undersigned until May 12, 2004 to respond.

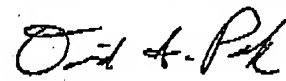
Please charge the fee of \$110.00 as set forth in the enclosed transmittal letter.

## Certificate of Facsimile Transmission

I hereby certify that this correspondence is being facsimile transmitted to the United States Patent and Trademark Office on the date shown below.

  
Linda BolterMay 12, 2004  
Date of Signature

Respectfully submitted,

  
David S. Park  
Attorney for Applicant  
Reg. No. 52,094

Serial No. 10/080,468

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